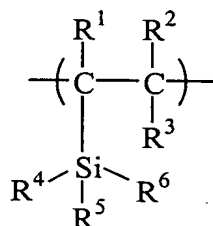


This listing of claims will replace all prior versions, and listings, of claims in the application:

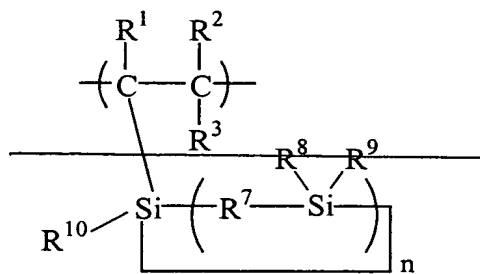
**Listing of Claims:**

Claim 1 (currently amended): A silicon-containing polymer comprising recurring units of at least one of the following general formulae (1) and (2):



(1)

wherein  $\text{R}^1$ ,  $\text{R}^2$  and  $\text{R}^3$  each are hydrogen or a straight, branched or cyclic alkyl group of 1 to 10 carbon atoms,  $\text{R}^4$ ,  $\text{R}^5$  and  $\text{R}^6$  each are independently an alkyl or haloalkyl group having 1 to 20 carbon atoms, an aryl group having 6 to 20 carbon atoms or a silicon-containing group attached to the silicon atom through a siloxane or silalkylene linkage,

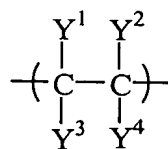


(2)

Claim 2 (original): The silicon-containing polymer of claim 1 further comprising recurring units of the general formula (3):



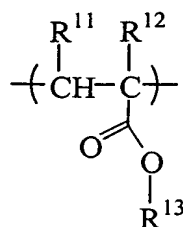
Claim 3 (original): The silicon-containing polymer of claim 1 further comprising recurring units of the general formula (4):



(4)

wherein Y<sup>1</sup>, Y<sup>2</sup>, Y<sup>3</sup> and Y<sup>4</sup> are independently selected from the class consisting of hydrogen, fluorine, chlorine, bromine, cyano, alkoxycarbonyl, fluorinated alkyl and fluorinated alkoxycarbonyl groups.

Claim 4 (original): The silicon-containing polymer of claim 1 further comprising recurring units of the general formula (5):



(5)

wherein R<sup>11</sup> and R<sup>12</sup> each are hydrogen or a straight, branched or cyclic alkyl group of 1 to 10 carbon atoms, and R<sup>13</sup> is an acid labile group or adhesive group.

Claim 5 (original): A resist composition comprising the polymer of claim 1.

Claim 6 (original): A chemically amplified, positive resist composition comprising

- (A) the polymer of claim 1,
- (B) a photoacid generator, and
- (C) an organic solvent.

Claim 7 (original): The resist composition of claim 6 further comprising (D) a dissolution inhibitor.

Claim 8 (original): The resist composition of claim 6 further comprising (E) a basic compound.

Claim 9 (original): A process for forming a resist pattern comprising the steps of:  
applying the resist composition of any one of claims 5 to 8 onto a substrate to form a resist layer,  
heat treating the resist layer and then exposing it to high-energy radiation having a wavelength of up to 300 nm or electron beam through a photo mask, and  
optionally heat treating the exposed resist layer and developing it with a developer.

Claim 10 (original): A process for forming a resist pattern comprising the steps of:  
applying the resist composition of any one of claims 5 to 8 onto a processable substrate formed on a support substrate through an organic film to form a resist layer,  
heat treating the resist layer and then exposing it to high-energy radiation having a wavelength of up to 300 nm or electron beam through a photo mask,  
optionally heat treating the exposed resist layer and developing it with a developer,  
and  
treating the organic film and the processable substrate by an etching process including oxygen plasma etching at the portions where the exposed resist layer portions are removed by developing.

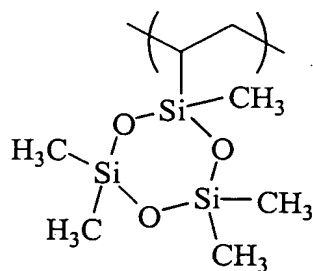
Claim 11 (original): The process of claim 10 wherein the organic film is a novolac resin or polyhydroxystyrene layer.

Claim 12 (original): A process for forming a resist pattern comprising the steps of:  
applying the resist composition of any one of claims 5 to 8 onto a processable substrate formed on a support substrate to form a resist layer,  
heat treating the resist layer and then exposing it to high-energy radiation having a wavelength of up to 300 nm or electron beam through a photo mask,  
optionally heat treating the exposed resist layer and developing it with a developer,  
and

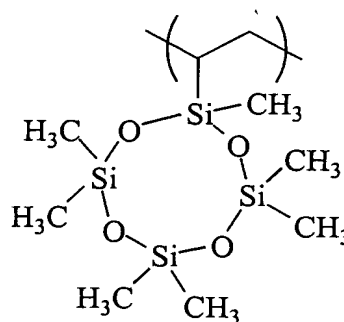
Claim 13 (new): The silicon-containing polymer of claim 1, wherein the recurring unit of formula (1) is at least one of formulae (1)-1 to (1)-8



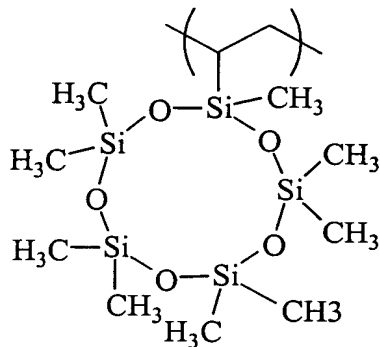
Claim 14 (new): The silicon-containing polymer of claim 1, wherein the recurring unit of formula (2) is at least one of formulae (2)-1 to (4)-8



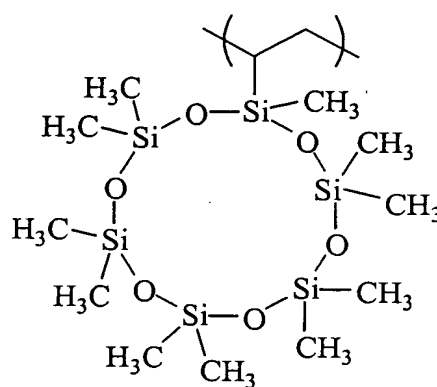
(2)-1



(2)-2

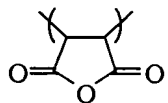


(2)-3

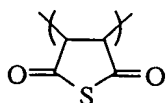


(2)-4

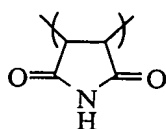
Claim 15 (new): The silicon-containing polymer of claim 2, wherein the recurring unit of formula (3) is at least one of formulae (3)-1 to (3)-11



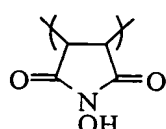
(3)-1



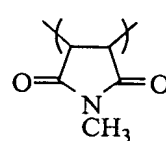
(3)-2



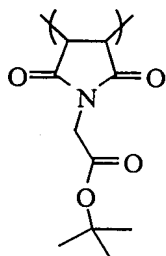
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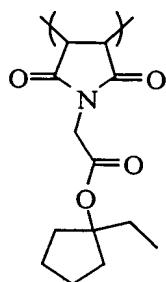
(3)-4



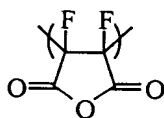
(3)-5



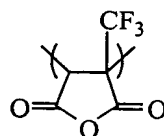
(3)-6



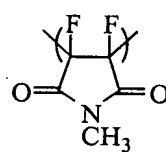
(3)-7



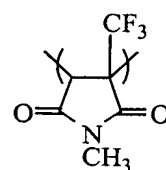
(3)-8



(3)-9

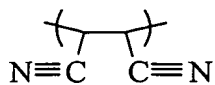


(3)-10

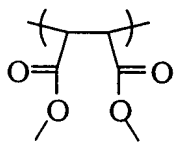


(3)-11

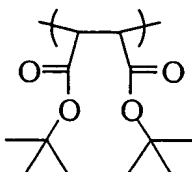
Claim 16 (new): The silicon-containing polymer of claim 3, wherein the recurring unit of formula (4) is at least one of formulae (4)-1 to (4)-10



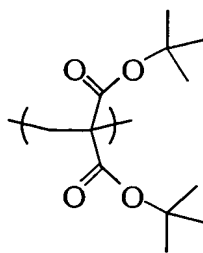
(4)-1



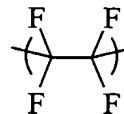
(4)-2



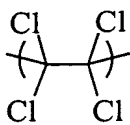
(4)-3



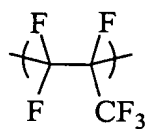
(4)-4



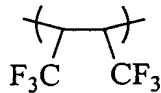
(4)-5



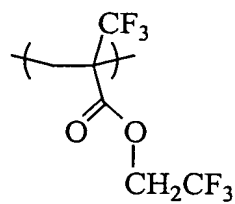
(4)-6



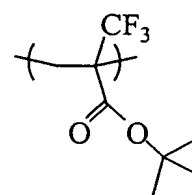
(4)-7



(4)-8



(4)-9



(4)-10